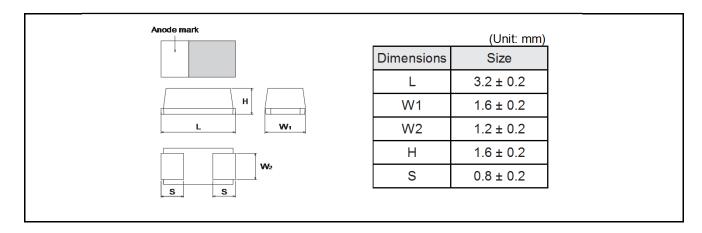
Conductive polymer chip capacitors (Bottom surface electrode type : Large capacitance)

TCTO Series A Case Datasheet

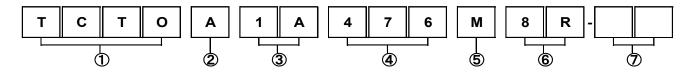
Features

- 1) Conductive polymer used at the cathode for ultra-low ESR.
- 2) Bottom electrode configuration results in the largest capacitance.
- 3) Compact, low profile, high capacitance contribute to smaller, thinner sets with greater functionality.
- 4) Conductive polymer has a self-healing function that prevents failure, resulting in safe, high reliability operation.

Dimensions



● Part No. Explanation



- ① Series name TCTO
- ② Case style A: 3216-18 (1206) size
- 3 Rated voltage

-	rated voltage						
	Rated voltage (V)	2.5	6.3	10	16	20	25
	CODE	0E	0J	1A	1C	1D	1E

- Nominal capacitance
 Nominal capacitance in pF in 3 digits:
 2 significant figures followed by the figure representing the number of 0's.
- ⑤ Capacitance tolerance

M: ±20%

6 Taping

8: Tape width

R: Positive electrode on the side opposite to sprocket hole

⑦ Discrimination code

^{*}This specification has possibility of charge, due to underdevelopment product. Please ask for latest specification to our sales.

Rated table

 $(ESR : m\Omega)$

Capacitance	Rated voltage (V.DC)								
(μF)	2.5	6.3	10	16					
10 (106)				☆200					
22 (226)									
47 (476)			200						
100 (107)		☆ 35/45							
150 (157)		☆35/200							
220 (227)	35								
330 (337)	☆ 35/ ☆ 200								

Marking

The indications listed below should be given on the surface of a capacitor.

- (1) Polarity: The polarity should be shown by bar. (on the anode side)
- (2) Rated DC voltage: A voltage code is shown as below table.
- (3) Capacitance: A capacitance code is shown as below table.

Voltage Code	Rated DC Voltage (V)				
е	2.5				
j	6.3				
A	10				
С	16				

Capacitance Code	Nominal Capacitance (μ F)				
а	10				
j	22				
S	47				
a	100				
e	150				
Ī	220				
n	330				

Visual typical example

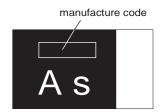
voltage code and capacitance code are variable with parts number.

[A case]

EX.)

A s (2)

(1) voltage code (2) capacitance code



Characteristics

						ance		Test conditions (based on JIS C 5101–1 and JIS C 5101–3)						
Operating Temp		–55°	°C to	+1	05°C	;		Voltage	e reduction when	n temperature exceeds +85	5°C			
Maximum opera with no voltage	ting temperature derating	+85°C												
Rated voltage (\	2.5	4	6.3	3 10) ,	16	at 85°C	at 85°C						
Category voltage (V.DC)			3.2	5	8	1:	2.8	at 105°	at 105°C					
Surge voltage (\	/.DC)	3.2	3.2 5 8 13 20					at 85°C	at 85°C					
DC Leakage current			Standard list "					As per	As per 4.9 JIS C 5101-1 As per 4.5.1 JIS C 5101-3 Voltage : Rated voltage for 5min					
Capacitance tole		±20% Shall be satisfied the voltage on " Standard list " Shall be satisfied the value on " Standard list "					As per Measu Measu	As per 4.7 JIS C 5101-1 As per 4.5.2 JIS C 5101-3 Measuring frequency: 120 ± 12Hz Measuring voltage: 0.5Vrms + 1.5V.DC Measuring circuit: DC Equivalent series circuit As per 4.8 JIS C 5101-1 As per 4.5.3 JIS C 5101-3 Measuring frequency: 120 ± 12Hz Measuring voltage: 0.5Vrms + 1.5V.DC Measuring circuit: DC Equivalent series circuit						
Tangent of loss							As per Measu Measu							
ESR							As per Measu Measu	As per 4.10 JIS C 5101-1 As per 4.5.4 JIS C 5101-3 Measuring frequency : 100 ± 10kHz Measuring voltage : 0.5Vrms or less Measuring circuit : DC Equivalent series circuit						
Resistance to Soldering heat	Appearance	Appearance There should be no significant abnormality. The indications shou be clear.							As per 4.14 JIS C 5101-1 As per 4.6 JIS C 5101-3 Dip in the solder bath					
	L.C.	Less	s than	n 3	00%	of in	nitial limit		Solder temp: 240 ± 5°C Duration: 10 ± 0.5s					
	⊿c/c	Within ±20% of initial value							Repetition : 1 After the specimens, leave it at room temperature for over 24h and then measure					
	Df (tan δ)	Less than 300% of initial limit						the sar	mple.					
Temperature cycle	ure Appearance There should be no significant abnormality. The indications shoul be clear.						•	uld As per Repeti	4.16 JIS C 510° 4.10 JIS C 510° tion : 5 cycles	1-3				
		be c	ıcaı.					(1 Cycl	e : steps 1 to 4)	without discontinuation.	Time			
	L.C.			n 10	000%	of of	initial limit	(i cycl		Temp55±3°C	Time 30±3min.			
	L.C.			n 10	000%	6 of	initial limit	(1 Cycl	1 2	Temp.	Time 30±3min. 3min. or less			
	L.C.			n 10	000%	6 of	initial limit	(1 cycl	1	Temp. −55±3°C	30±3min.			
	L.C. ⊿c/c	Less	s than				initial limit	- (1 cycli	1 2	Temp. -55±3°C Room temp.	30±3min. 3min. or less			
		Less	s than					After th	1 2 3 4	Temp. -55±3°C Room temp. 105±2°C Room temp.	30±3min. 3min. or less 30±3min.			
		Less	s than	20%	6 of i	nitia			1 2 3 4	Temp. -55±3°C Room temp. 105±2°C Room temp.	30±3min. 3min. or less 30±3min. 3min. or less			
Moisture resistance	⊿c/c	Less With Less The	s than	n 3	% of in	of in	al value	After the sar the sar As per As per After le	1 2 3 4 4 ne specimens, lemple. 4.22 JIS C 5107 4.12 JIS C 5107 eaving the samp	Temp. -55±3°C Room temp. 105±2°C Room temp. eave it at room temperature	30±3min. 3min. or less 30±3min. 3min. or less e for over 24h and then measure			
	⊿C / C Df (tan δ)	With Less The abnote of	s than	20% n 3 oul	6 of in	of inde	al value nitial limit significant	After the sar As per As per After le humidi	1 2 3 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4	Temp. -55±3°C Room temp. 105±2°C Room temp. eave it at room temperature 1-1 1-3 le under such atmospheric and 90 to 95% RH, respecti	30±3min. 3min. or less 30±3min. 3min. or less e for over 24h and then measure condition that the temperature a vely, for 500±12h leave it at room			
	⊿C / C Df (tan δ) Appearance	Less With Less The abno	s than	n 3 oul lity	% of in 00% d be . The 00%	of in	al value nitial limit significant lications sho	After the sar As per As per After le humidi	1 2 3 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4 4	Temp. -55±3°C Room temp. 105±2°C Room temp. eave it at room temperature	30±3min. 3min. or less 30±3min. 3min. or less e for over 24h and then measure condition that the temperature a vely, for 500±12h leave it at room			

	L.C.	Less than 1,000% of initial limit				
		<u>'</u>				
Surge voltage	Appearance	There should be no significant abnormality.	As per 4.26JIS C 5101-1 As per 4.14JIS C 5101-3			
	L.C.	Less than 200% of initial limit	Apply the specified surge voltage via the serial resistance of $1k\Omega$ ever 5 ± 0.5 min. for 30 ± 5 s. each time in the atmospheric condition of $85\pm2^\circ$			
	⊿c/c	Within ±20% of initial value	C. Repeat this procedure 1,000 times.			
	Df (tan δ)	Less than 200% of initial limit	After the specimens, leave it at room temperature for over 24h and then measure the sample.			
Loading at High temperature	Appearance	There should be no significant abnormality. The indications should be clear.	As per 4.23 JIS C 5101-1 As per 4.15 JIS C 5101-3			
riigir terriperature	L.C.	Less than 400% of initial limit	After applying the rated voltage for 1000+72/0 h without discontinuation			
	∠C/C	Within ±20% of initial value	via the serial resistance of 3Ω or less at a temperature of $85\pm2^{\circ}$ C,			
	Df (tan δ)	Less than 300% of initial limit	leave the sample at room temperature / humidity for over 24h and measure the value.			
Terminal strength		The measured value should be stable.	As per 4.35 JIS C 5101-1			
reminal strength	Сараспансе	The measured value should be stable.	As per 4.39 JIS C 5101-3 A force is applied to the terminal until it bends to 1mm and by a prescribed tool maintains the condition for 5s.			
Adhesiveness		The terminal should not come off.	As per 4.34 JIS C 5101-1 As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10 ±1s after mounting the terminal on a circuit board.			
Dimensions Resistance to solv	unto.	Refer to "External dimensions"	Apply force a circuit board Measure using a caliper of JIS B 7507 Class 2 or higher grade.			
Resistance to solv	rents	The indication should be clear.	As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.			
Solderability		3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.	As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75%			
Vibration	Capacitance	Measure value should not fluctuate during the measurement.	As per 4.17 JIS C 5101-1 Frequency : 10 to 55 to 10Hz/min. Amplitude : 1.5mm			
	Appearance	There should be no significant abnormality.	Time: 2h each in X and Y directions Mounting: The terminal is soldered on a print circuit board.			

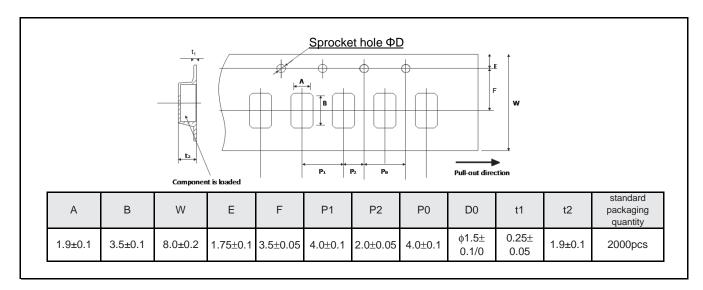
Standard products list

Part No.	Rated voltage 85°C	Category voltage 105°C	Surge voltage 85°C	Cap. 120Hz	Toleranc e	Leakage current 25° C 1WV.5min	Df 120Hz (%)			ESR 100kHz
	(V) (V) (μF)	(%)	(μ A)	–55°C	25°C	105°C	(mΩ)			
TCTO A 0E 227 M8R-ZN1	2.5	2	3.2	220	± 20	55	15	15	20	35
* TCTO A 0E 337 M8R-ZN1	2.5	2	3.2	330	± 20	82.5	15	15	20	35
* TCTO A 0E 337 M8R-ZD1	2.5	2	3.2	330	± 20	82.5	15	15	20	200
* TCTO A 0J 107 M8R-ZN1	6.3	5	8	100	± 20	63	15	15	20	35
TCTO A 0J 107 M8R-ZS1	6.3	5	8	100	± 20	63	15	15	20	45
* TCTO A 0J 157 M8R-ZN1	6.3	5	8	150	± 20	94.5	15	15	20	35
TCTO A 0J 157 M8R	6.3	5	8	150	± 20	94.5	15	15	20	200
TCTO A 1A 476 M8R	10	8	13	47	± 20	47	10	10	15	200
* TCTO A 1C 106 M8R-ZD1	16	12.8	20	10	± 20	16	10	10	15	200

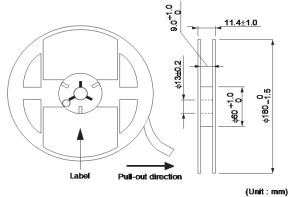
^{* =} Under development

Please contact us for specification of low ESR products.

Packaging specifications



Reel dimensions



(Unit : mm) EIAJ ET-7200A

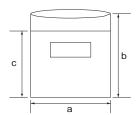
Damp proof package

①One reel is packed in aluminum bag.

The size of aluminum bag is 240(a) x 250(b)mm.

The size up to 230(c)mm is to zipper.

- ②A desiccant is packed with a reel.
- $\ensuremath{\mathfrak{G}}$ The aluminum bag is heat-sealed.
- (4) The label of the same as the label on the reel is placed on the aluminum bag.



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(Note1) Medical Equipment Classification of the Specific Applications

1 /				
JAPA	N	USA	EU	CHINA
CLASS	эш	CLASSIII	CLASS II b	CLASSIII
CLASS	SIV	CLASSIII	CLASSⅢ	CLASSIII

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 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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Notice-PGA-E Rev.004

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TCQY336M016R0070E TCBD157M006CRSZ0H00E T520V157M004ATE015 T520T106M12RATE150 T545V476M016ATE045
T5271107M006ATE200 T523H157M025APE070 T525B336M006AHE080 TCNX476M035R0150 F381A336MSALZT
FA1E566M10126VR T520X477M006AHE040 T541X336M050BH6710 T541X337M016BH6720 293D106X9025C2WE3
NTP106M10TRB(200)F NTP157M10TRD(40)F NTP337M2.5TRV(15)F NTP157M10TRD(55)F